

# 1A, 50V - 1000V High Efficient Bridge Rectifier

#### **FEATURES**

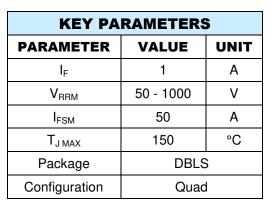
- AEC-Q101 qualified available
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

#### **MECHANICAL DATA**

- · Case: DBLS
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.360g (approximately)



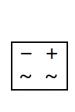


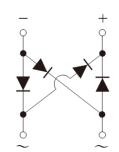






**DBLS** 





PARAMETER	SYMBOL	<b>HDBLS</b>	<b>HDBLS</b>	<b>HDBLS</b>	<b>HDBLS</b>	<b>HDBLS</b>	<b>HDBLS</b>	<b>HDBLS</b>	UNIT
		101G	102G	103G	104G	105G	106G	107G	ONII
Marking code on the device		HDBLS 101G	HDBLS 102G	HDBLS 103G	HDBLS 104G	HDBLS 105G	HDBLS 106G	HDBLS 107G	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Forward current	I <sub>F</sub>	1			Α				
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50			Α				
Rating for fusing (t<8.3ms)	l <sup>2</sup> t	l <sup>2</sup> t 10.3			A <sup>2</sup> s				
Junction temperature	TJ	T <sub>J</sub> - 55 to +150			°C				
Storage temperature	T <sub>STG</sub>	- 55 to +150			°C				

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	15	°C/W	
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	40	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	HDBLS101G HDBLS102G HDBLS103G			-	1.0	V
Forward voltage per diode	HDBLS104G		V <sub>F</sub>	-	1.3	V
	HDBLS105G HDBLS106G HDBLS107G			-	1.7	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>		T <sub>J</sub> = 25°C	I <sub>R</sub>	-	5	μΑ
		T <sub>J</sub> = 125°C		-	500	μΑ
Reverse recovery time	HDBLS101G HDBLS102G HDBLS103G HDBLS104G	$I_F = 0.5A$ , $I_R = 1.0A$ , $I_{rr} = 0.25A$	- t <sub>rr</sub>	50	ns	
	HDBLS105G HDBLS106G HDBLS107G			-	75	ns

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING		
HDBLS1xG	DBLS	1,500 / Tape & Reel		
HDBLS1xGH	DBLS	1,500 / Tape & Reel		

#### Notes:

- 1. "x" defines voltage from 50V(HDBLS101G) to 1000V(HDBLS107G)
- 2. "H" means AEC-Q101 qualified



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

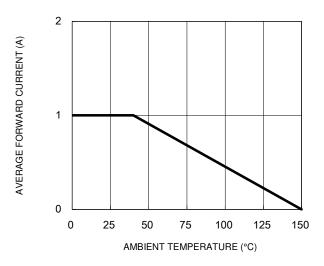
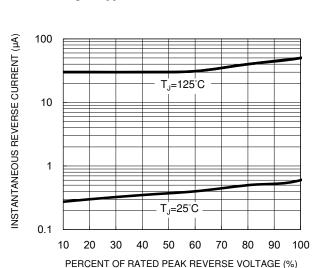


Fig.3 Typical Reverse Characteristics



**Fig.2 Typical Junction Capacitance** 

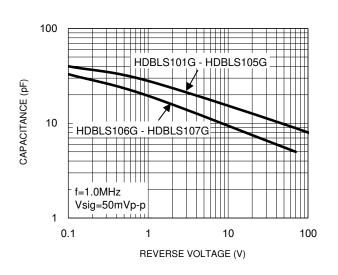


Fig.4 Typical Forward Characteristics

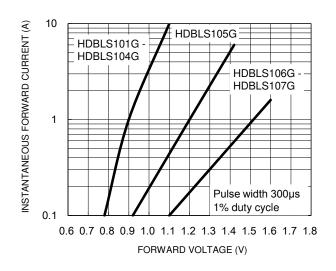
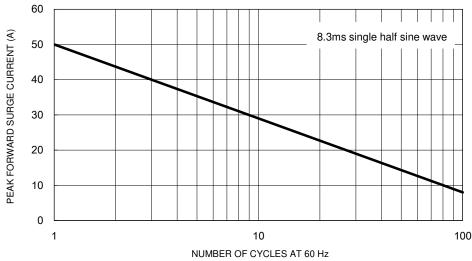


Fig.5 Maximum Non-Repetitive Forward Surge Current



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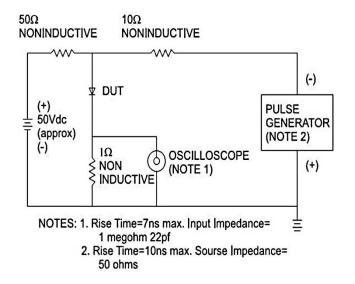


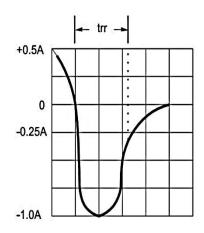
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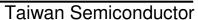
## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

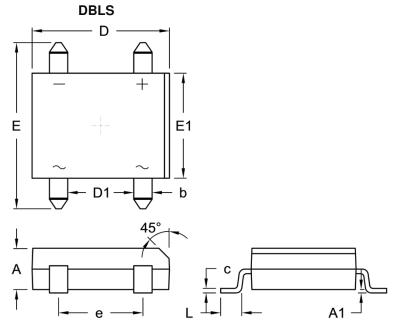






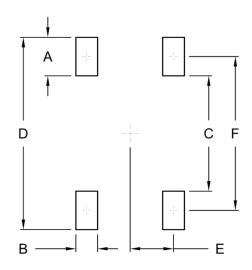


## **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	2.40	2.60	0.094	0.102	
A1	0.076	0.330	0.003	0.013	
b	1.02	1.20	0.040	0.047	
С	0.22	0.33	0.009	0.013	
D	8.13	8.51	0.320	0.335	
D1	3.90	4.10	0.154	0.161	
E	9.80	10.30	0.386	0.406	
E1	6.20	6.50	0.244	0.256	
е	5.00	5.20	0.197	0.205	
L	1.02	1.53	0.040	0.060	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	2.30	0.091
В	1.30	0.051
С	6.90	0.272
D	11.50	0.453
E	2.60	0.102
F	9.20	0.362

# **MARKING DIAGRAM**



P/N = Marking Code

G = Green Compound

YW = Date Code
F = Factory Code



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